

NOTE

- 1 Mounting side is mated with the receptacle : IT3M-***S-BGA(**) with equal number of positions and attached with the latch.
- 2 Lot no. shall be marked on the indicated position.
- 3 The indicated mother board and daughter card shall be fastened to the additional reinforcements to prevent the stress on IT3-***S-BGA(**) solder joints.
4. More information of this product is available in HIROSE document : ETAD-F0347 "IT3 Design Guideline".
5. This product consists of "F" signal lines and "G" ground lines.
6. "H" pcs of this products are packaged in a soft tray.
7. This is plug.
8. This product is RoHS compliant.
9. Standard package of "K" pcs are packaged in a carton box.

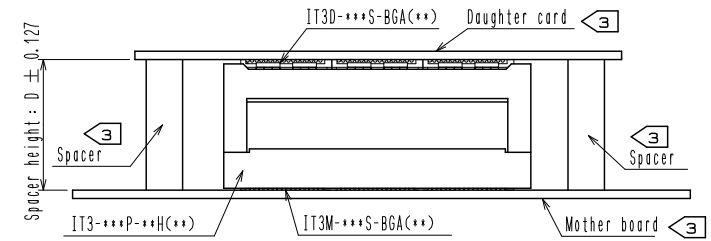
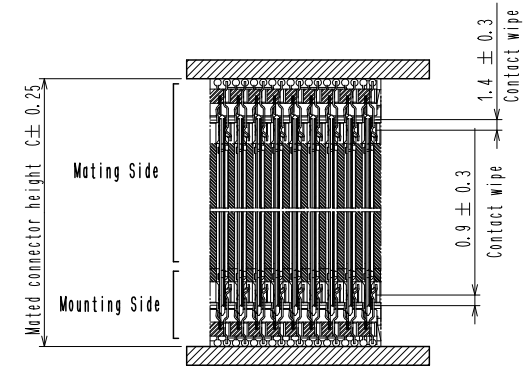


Fig. 1(FREE)



Mating Cross Section(FREE)

5	GND PLATE **H	M702C-H	G	Contact area : Ni1.5μm±Au0.76μm	
4	P CONTACT **H	M702C-H	F	Contact area : Ni1.5μm±Au0.76μm	
3	BLADE **H	LCP-M	E		UL94V-0. BLACK
2	GUIDE ***S-***H	cf. Left Table : J	1		UL94V-0. GRAY
1	GUIDE ***P	PBT-M	1		UL94V-0. BLACK
NO.	TITLE	MATERIAL	QTY	FINISH	REMARKS
UNITS	mm	SCALE	2 : 1	REV COUNT	Δ 10
		DESCRIPTION OF REVISIONS	DESIGNED	CHECKED	DATE
		DIS-F-004000	J. HUANG	TM. MATSUO	11.05.11
		APPROVED : TM. MATSUO	09.03.12	DRAWING NO.	EDC3-159915-01
		CHECKED : TM. MATSUO	09.03.12	PART NO.	IT3-***P-***H(C03)
		DESIGNED : MN. MANATA	09.03.12	CODE NO.	CL636
		DRAWN : MN. MANATA	09.03.12		

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